# NX3DV3899

# Dual double-pole double-throw analog switch Rev. 3 — 9 November 2011

**Product data sheet** 

#### **General description** 1.

The NX3DV3899 is a dual double-pole double-throw analog data-switch suitable for use as an analog or digital multiplexer/demultiplexer. It consists of four switches, each with two independent input/outputs (nY0 and nY1) and a common input/output (nZ). The two digital inputs (1S and 2S) are used to select the switch position. Schmitt trigger action at the select input (nS) makes the circuit tolerant to slower input rise and fall times across the entire V<sub>CC</sub> range from 1.4 V to 4.3 V.

A low input voltage threshold allows pin nS to be driven by lower level logic signals without a significant increase in supply current I<sub>CC</sub>. This makes it possible for the NX3DV3899 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3DV3899 allows signals with amplitude up to V<sub>CC</sub> to be transmitted from nZ to nY0 or nY1; or from nY0 or nY1 to nZ.

#### **Features and benefits** 2.

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
  - 7.2 Ω (typical) at V<sub>CC</sub> = 1.4 V
  - 5.4 Ω (typical) at V<sub>CC</sub> = 1.65 V
  - 2.9 Ω (typical) at V<sub>CC</sub> = 2.5 V
  - 2.4 Ω (typical) at V<sub>CC</sub> = 3.0 V
  - 2.3 Ω (typical) at V<sub>CC</sub> = 3.6 V
  - 2.2 Ω (typical) at V<sub>CC</sub> = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
  - ♦ HBM JESD22-A114F Class 2A exceeds 2000 V (all pins)
  - ◆ HBM JESD22-A114F Class 3A exceeds 5000 V (I/O pins to GND)
  - MM JESD22-A115-A exceeds 200 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78B Class II Level A
- 1.8 V control logic at V<sub>CC</sub> = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V<sub>CC</sub>
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



#### Dual double-pole double-throw analog switch

## 3. Applications

- Data switch
- Cell phone
- PDA
- Portable media player

## 4. Ordering information

Table 1. Ordering information

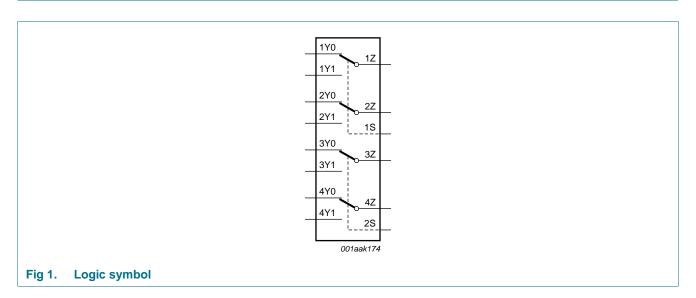
Type number	Package								
	Temperature range	Name	Description	Version					
NX3DV3899HR	–40 °C to +125 °C	HXQFN16U	plastic thermal enhanced extremely thin quad flat package; no leads; 16 terminals; UTLP based; body $3\times3\times0.5~\text{mm}$	SOT1039-1					
NX3DV3899GU	–40 °C to +125 °C	XQFN16	plastic, extremely thin quad flat package; no leads; 16 terminals; body 1.80 $\times$ 2.60 $\times$ 0.50 mm	SOT1161-1					

## 5. Marking

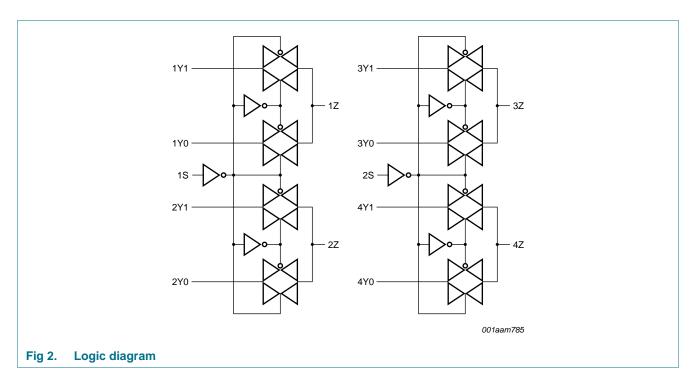
Table 2. Marking codes

Type number	Marking code
NX3DV3899HR	×99
NX3DV3899GU	×9

## 6. Functional diagram

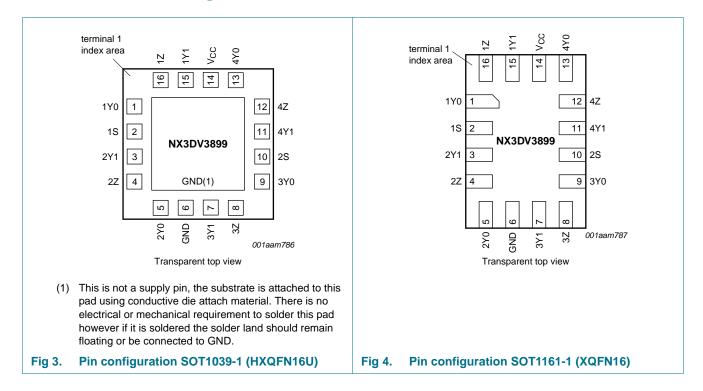


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## 7. Pinning information

#### 7.1 Pinning



#### Dual double-pole double-throw analog switch

#### 7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
1Y0, 2Y0, 3Y0, 4Y0	1, 5, 9, 13	independent input or output
1S, 2S	2, 10	select input
1Y1, 2Y1, 3Y1, 4Y1	15, 3, 7, 11	independent input or output
1Z, 2Z, 3Z, 4Z	16, 4, 8, 12	common output or input
GND	6	ground (0 V)
V <sub>CC</sub>	14	supply voltage

## 8. Functional description

Table 4. Function table[1]

Input nS	Channel on
L	nY0
Н	nY1

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level.

## 9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+4.6	V
VI	input voltage	select input nS	<u>[1]</u> –0.5	+4.6	V
V <sub>SW</sub>	switch voltage		<u>[2]</u> −0.5	$V_{CC} + 0.5$	V
I <sub>IK</sub>	input clamping current	$V_1 < -0.5 \text{ V}$	-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	±50	mA
I <sub>SW</sub>	switch current	$V_{SW} > -0.5 \text{ V or } V_{SW} < V_{CC} + 0.5 \text{ V};$ source or sink current	-	±350	mA
		$V_{\rm SW}$ > -0.5 V or $V_{\rm SW}$ < $V_{\rm CC}$ + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$			
		HXQFN16U	[3] _	250	mW
		XQFN16	<u>[4]</u> _	250	mW

<sup>[1]</sup> The minimum input voltage rating may be exceeded if the input current rating is observed.

<sup>[2]</sup> The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

<sup>[3]</sup> For HXQFN16U package: above 135  $^{\circ}$ C the value of P<sub>tot</sub> derates linearly with 16.9 mW/K.

<sup>[4]</sup> For XQFN16 package: above 133  $^{\circ}$ C the value of P<sub>tot</sub> derates linearly with 14.5 mW/K.

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## 10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		1.4	4.3	V
VI	input voltage	select input nS	0	4.3	V
$V_{SW}$	switch voltage		<u>[1]</u> 0	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V <sub>CC</sub> = 1.4 V to 4.3 V	[2] _	200	ns/V

<sup>[1]</sup> To avoid sinking GND current from terminal nZ when switch current flows in terminal nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nYn. In this case, there is no limit for the voltage drop across the switch.

## 11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$			Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
$V_{IH}$	HIGH-level	$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	0.9	-	-	0.9	-	-	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	0.9	-	-	0.9	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.1	-	-	1.1	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	1.3	-	-	1.3	-	-	V
		V <sub>CC</sub> = 3.6 V to 4.3 V	1.4	-	-	1.4	-	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 1.4 V to 1.6 V	-	-	0.3	-	0.3	0.3	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.5	-	0.5	0.5	V
		V <sub>CC</sub> = 3.6 V to 4.3 V	-	-	0.6	-	0.6	0.6	V
I <sub>I</sub>	input leakage current	select input nS; $V_I = GND \text{ to } 4.3 \text{ V};$ $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-	-	-	±0.5	±1	μΑ
I <sub>S(OFF)</sub>	OFF-state leakage	nY0 and nY1 port; see Figure 5							
	current	$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-	±5	-	±50	±500	nA
I <sub>S(ON)</sub>	ON-state	nZ port; see Figure 6							
	leakage current	$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-	±5	-	±50	±500	nA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or $V_{CC}$							
		V <sub>CC</sub> = 3.6 V	-	-	100	-	500	5000	nA
		V <sub>CC</sub> = 4.3 V	-	-	150	-	800	6000	nA

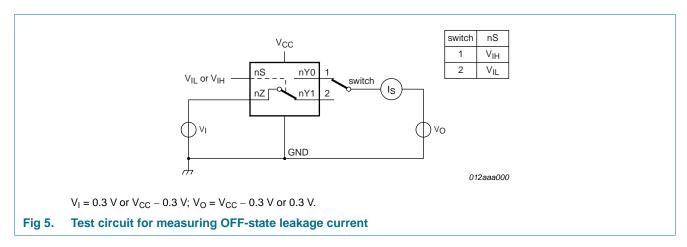
<sup>[2]</sup> Applies to control signal levels.

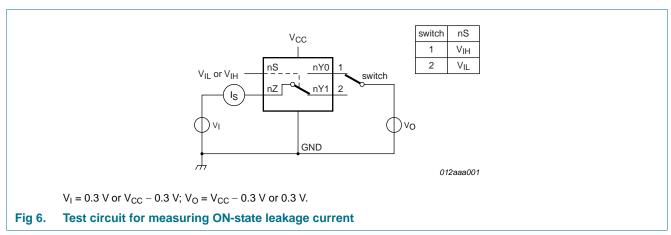
#### Dual double-pole double-throw analog switch

**Table 7. Static characteristics** ...continued
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> =	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
$\Delta I_{CC}$	additional	$V_{SW} = GND \text{ or } V_{CC}$							
	supply current	$V_{I} = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μΑ
		$V_{I} = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	0.35	0.7	-	1	1	μΑ
		$V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	7.0	10.0	-	15	15	μΑ
		V <sub>I</sub> = 1.8 V; V <sub>CC</sub> = 3.6 V	-	2.5	4.0	-	5	5	μΑ
		V <sub>I</sub> = 1.8 V; V <sub>CC</sub> = 2.5 V	-	50	200	-	300	500	nA
Cı	input capacitance		-	1.0	-	-	-	-	pF
$C_{\text{S(OFF)}}$	OFF-state capacitance		-	8	-	-	-	-	pF
C <sub>S(ON)</sub>	ON-state capacitance		-	30	-	-	-	-	pF

#### 11.1 Test circuits





#### Dual double-pole double-throw analog switch

#### 11.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 14.

Symbol	Parameter	Conditions	T <sub>amb</sub>	= -40 °C to	o +85 °C	$T_{amb} = -40^{\circ}$	°C to +125 °C	Unit
				Typ[1]	Max	Min	Max	
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = GND$ to $V_{CC}$ ; $I_{SW} = 100$ mA; see <u>Figure 7</u>						
		$V_{CC} = 1.4 \text{ V}$	-	7.2	9.3	-	10	Ω
		V <sub>CC</sub> = 1.65 V	-	5.4	7.3	-	8	Ω
		$V_{CC} = 2.5 \text{ V}$	-	2.9	3.9	-	4.5	Ω
		$V_{CC} = 3.0 \text{ V}$	-	2.4	3.4	-	4.5	Ω
		$V_{CC} = 3.6 \text{ V}$	-	2.3	3.3	-	4.2	Ω
		$V_{CC} = 4.3 \text{ V}$	-	2.2	3.3	-	4.2	Ω
$\Delta R_{ON}$	ON resistance mismatch	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	2]					
	between channels	$V_{CC} = 3.0 \text{ V}$	-	0.8	-	-	-	Ω
	Chamileis	$V_{CC} = 4.3 \text{ V}$	-	0.7	-	-	-	Ω
R <sub>ON(flat)</sub>	ON resistance (flatness)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	<u>3]</u>					
		$V_{CC} = 1.4 \text{ V}$	-	4.4	-	-	-	Ω
		V <sub>CC</sub> = 1.65 V	-	2.8	-	-	-	Ω
		$V_{CC} = 2.5 \text{ V}$	-	1.0	-	-	-	Ω
		$V_{CC} = 3.0 \text{ V}$	-	0.8	-	-	-	Ω
		$V_{CC} = 3.6 \text{ V}$	-	0.9	-	-	-	Ω
		$V_{CC} = 4.3 \text{ V}$	-	1.0	-	-	-	Ω

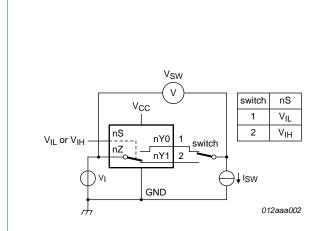
<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C.

<sup>[2]</sup> Measured at identical V<sub>CC</sub>, temperature and input voltage.

<sup>[3]</sup> Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

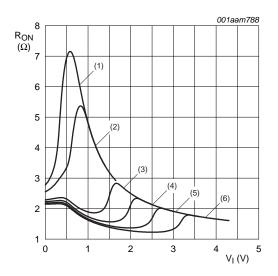
#### Dual double-pole double-throw analog switch

## 11.3 ON resistance test circuit and graphs



 $R_{ON} = V_{SW} / I_{SW}$ 

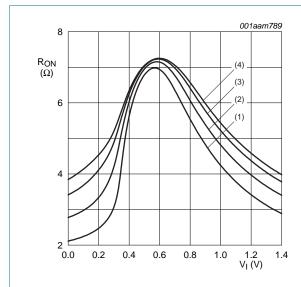
Fig 7. Test circuit for measuring ON resistance



- (1)  $V_{CC} = 1.4 \text{ V}.$
- (2)  $V_{CC} = 1.65 \text{ V}.$
- (3)  $V_{CC} = 2.5 \text{ V}.$
- (4)  $V_{CC} = 3.0 \text{ V}.$
- (5)  $V_{CC} = 3.6 \text{ V}.$ (6)  $V_{CC} = 4.3 \text{ V}.$ 
  - Measured at  $T_{amb} = 25 \, ^{\circ}C$ .

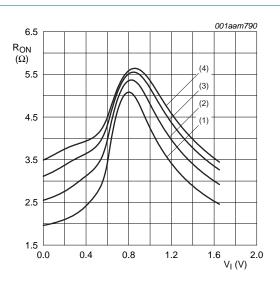
Fig 8. Typical ON resistance as a function of input voltage

#### Dual double-pole double-throw analog switch



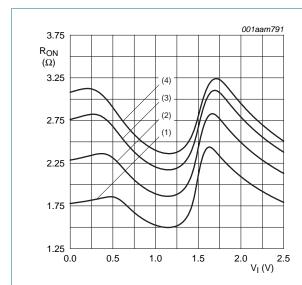
- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 9. ON resistance as a function of input voltage;  $V_{CC} = 1.4 \text{ V}$ 



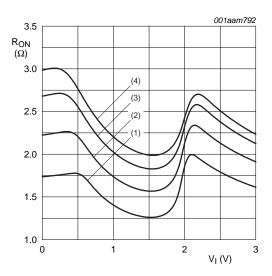
- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 10. ON resistance as a function of input voltage;  $V_{CC} = 1.65 \text{ V}$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C.$
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

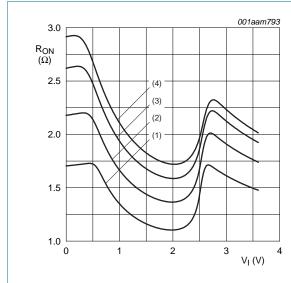
Fig 11. ON resistance as a function of input voltage;  $V_{CC} = 2.5 \text{ V}$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

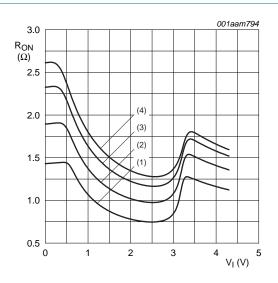
Fig 12. ON resistance as a function of input voltage;  $V_{CC} = 3.0 \text{ V}$ 

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- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 13. ON resistance as a function of input voltage;  $V_{CC} = 3.6 \text{ V}$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 14. ON resistance as a function of input voltage;  $V_{CC} = 4.3 \text{ V}$ 

## 12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 17.

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> =	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
t <sub>en</sub>	enable time	nS to nZ or nYn; see Figure 15							
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	41	90	-	120	120	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	30	70	-	80	90	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	20	45	-	50	55	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	19	40	-	45	50	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	19	40	-	45	50	ns
t <sub>dis</sub>	disable time	nS to nZ or nYn; see <u>Figure 15</u>							
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	24	70	-	80	90	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	15	55	-	60	65	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	9	25	-	30	35	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	8	20	-	25	30	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	8	20	-	25	30	ns

## Dual double-pole double-throw analog switch

 Table 9.
 Dynamic characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 17.

Symbol	Parameter	Conditions	Ta	<sub>imb</sub> = 25	°C	T <sub>amb</sub> =	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
t <sub>b-m</sub>	break-before-make	see Figure 16	2]						
	time	$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	20	-	9	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	17	-	7	-	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	13	-	4	-	-	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	11	-	3	-	-	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	11	-	2	-	-	ns

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

#### 12.1 Waveform and test circuits

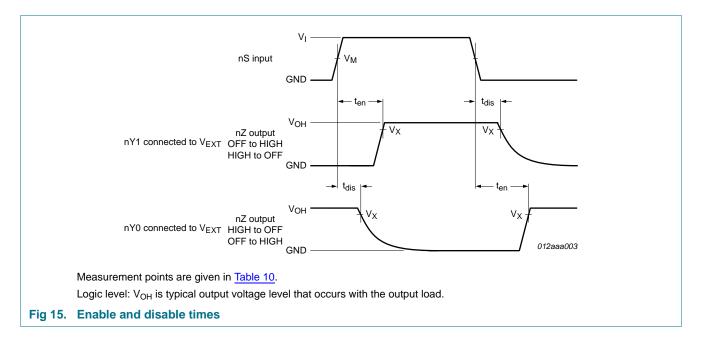
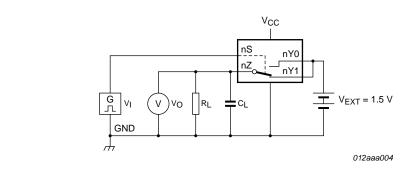


Table 10. Measurement points

Supply voltage	Input	Output
V <sub>CC</sub>	V <sub>M</sub>	V <sub>X</sub>
1.4 V to 4.3 V	0.5V <sub>CC</sub>	0.9V <sub>OH</sub>

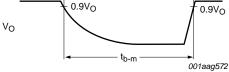
<sup>[2]</sup> Break-before-make guaranteed by design.

#### Dual double-pole double-throw analog switch



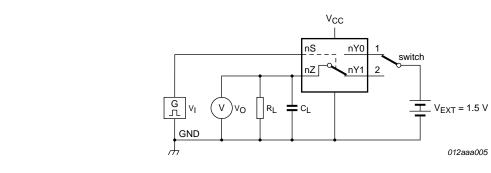
a. Test circuit





b. Input and output measurement points

Fig 16. Test circuit for measuring break-before-make timing



Test data is given in Table 11.

Definitions test circuit:

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 17. Test circuit for measuring switching times

Table 11. Test data

Supply voltage	Input		Load	
V <sub>CC</sub>	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	R <sub>L</sub>
1.4 V to 4.3 V	$V_{CC}$	≤ 2.5 ns	35 pF	50 Ω

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#### Dual double-pole double-throw analog switch

## 12.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

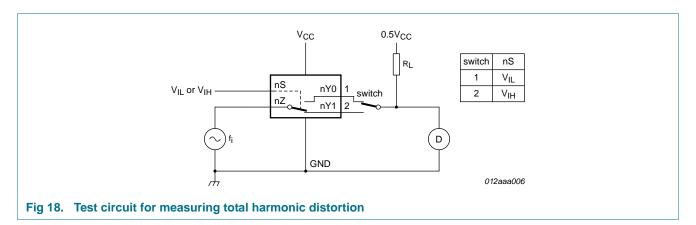
At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_l = \text{GND}$  or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 2.5$  ns;  $T_{amb} = 25$  °C.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD total harmonic distortion	$f_i$ = 20 Hz to 20 kHz; $R_L$ = 600 $\Omega$ ; see Figure 18	<u>[1]</u>				
	$V_{CC} = 1.4 \text{ V}; V_{I} = 1 \text{ V (p-p)}$	-	0.05	-	%	
	$V_{CC} = 1.65 \text{ V}; V_I = 1.2 \text{ V (p-p)}$	-	0.02	-	%	
	$V_{CC} = 2.3 \text{ V}; V_{I} = 1.5 \text{ V (p-p)}$	-	0.01	-	%	
		$V_{CC} = 2.7 \text{ V}; V_{I} = 2 \text{ V (p-p)}$	-	0.01	-	%
		$V_{CC} = 3.6 \text{ V}; V_{I} = 2 \text{ V (p-p)}$	-	0.01	-	%
		$V_{CC} = 4.3 \text{ V}; V_{I} = 2 \text{ V (p-p)}$	-	0.01	-	%
f <sub>(-3dB)</sub>	-3 dB frequency	$R_L = 50 \Omega$ ; see Figure 19	[1]			
response	$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	200	-	MHz	
$\alpha_{iso}$	isolation (OFF-state)	$f_i = 1 \text{ MHz}$ ; $R_L = 50 \Omega$ ; see Figure 20	[1]			
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-70	-	dB
V <sub>ct</sub> crosstalk voltage	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$ ; $C_L = 50 \text{ pF}$ ; $R_L = 50 \Omega$ ; see Figure 21				
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	210	-	V
	$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	300	-	V	
Xtalk crosstalk	between switches; $f_i = 1 \text{ MHz}$ ; $R_L = 50 \Omega$ ; see Figure 22	<u>[1]</u>				
	$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-90	-	dB	
Q <sub>inj</sub> charge injection	$f_i$ = 1 MHz; $C_L$ = 0.1 nF; $R_L$ = 1 M $\Omega$ ; $V_{gen}$ = 0 V; $R_{gen}$ = 0 $\Omega$ ; see Figure 23					
	V <sub>CC</sub> = 1.4 V	-	0.5	-	рС	
	V <sub>CC</sub> = 1.65 V	-	0.7	-	рС	
	V <sub>CC</sub> = 2.5 V	-	1.6	-	рC	
	$V_{CC} = 3.0 \text{ V}$	-	2.1	-	рC	
		$V_{CC} = 3.6 \text{ V}$	-	2.9	-	рC
		V <sub>CC</sub> = 4.3 V	-	4.0	-	рС

<sup>[1]</sup>  $f_i$  is biased at  $0.5V_{CC}$ .

#### Dual double-pole double-throw analog switch

#### 12.3 Test circuits



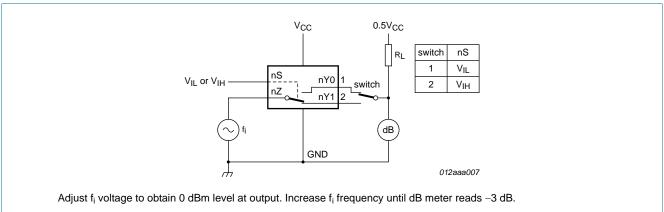
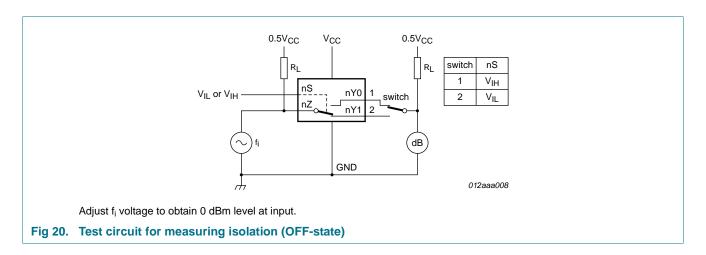
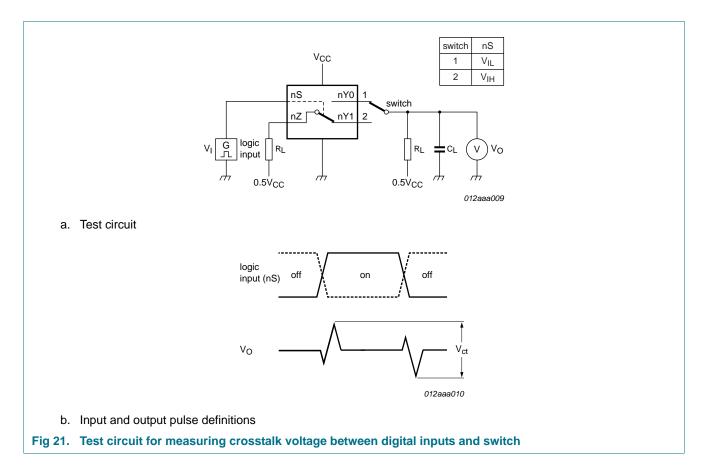
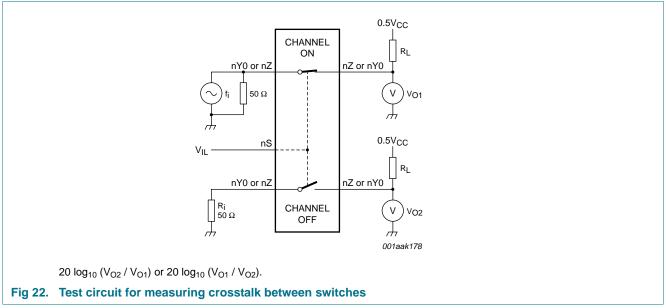


Fig 19. Test circuit for measuring the frequency response when channel is in ON-state

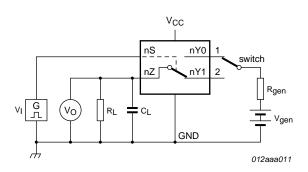


#### Dual double-pole double-throw analog switch

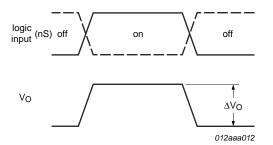




#### Dual double-pole double-throw analog switch



a. Test circuit



b. Input and output pulse definitions

Definition:  $Q_{inj} = \Delta V_O \times C_L$ .

 $\Delta V_{O}$  = output voltage variation.

R<sub>gen</sub> = generator resistance.

 $V_{gen}$  = generator voltage.

Fig 23. Test circuit for measuring charge injection

#### Dual double-pole double-throw analog switch

## 13. Package outline

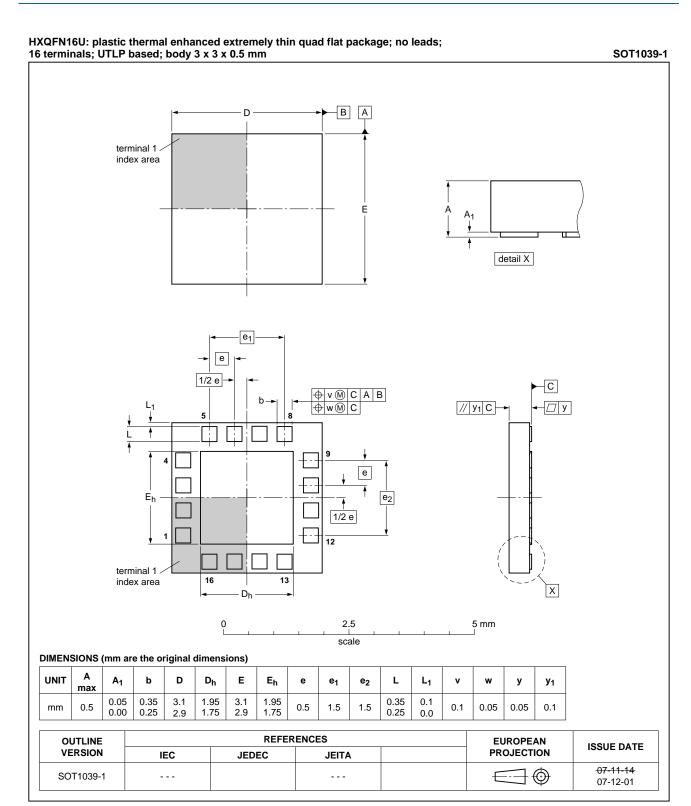


Fig 24. Package outline SOT1039-1 (HXQFN16U)

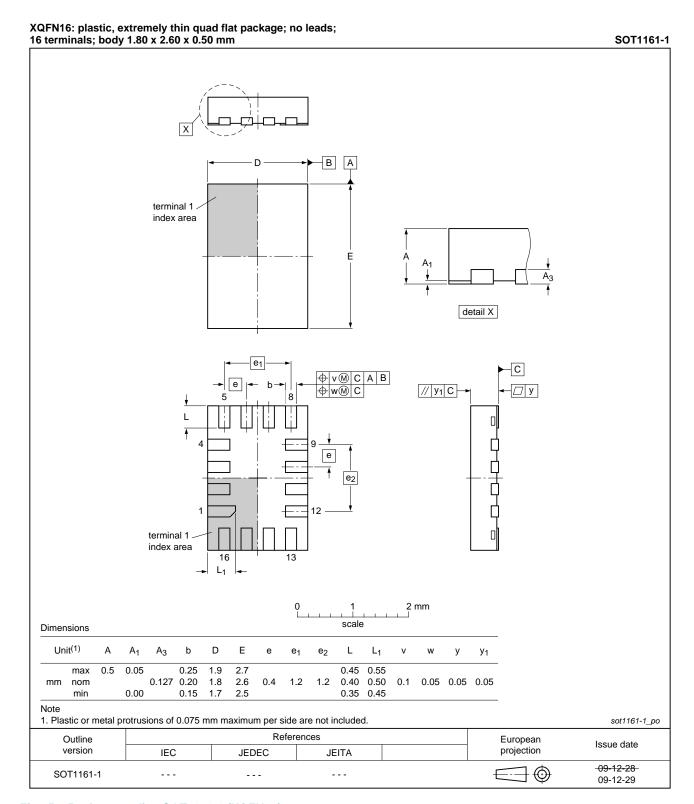


Fig 25. Package outline SOT1161-1 (XQFN16)

NX3DV3899

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## Dual double-pole double-throw analog switch

## 14. Abbreviations

#### Table 13. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
PDA	Personal Digital Assistant

## 15. Revision history

#### Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3DV3899 v.3	20111109	Product data sheet	-	NX3DV3899 v.2
Modifications:	<ul> <li>Legal pages</li> </ul>	updated.		
NX3DV3899 v.2	20101123	Product data sheet	-	NX3DV3899 v.1
NX3DV3899 v.1	20101021	Product data sheet	-	-

#### Dual double-pole double-throw analog switch

## 16. Legal information

#### 16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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